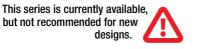
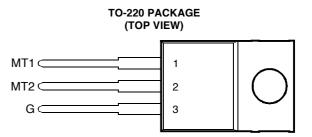
# BOURNS®

- Sensitive Gate Triacs
- 2.5 A RMS
- Glass Passivated Wafer
- 400 V to 700 V Off-State Voltage
- Max I<sub>GT</sub> of 5 mA (Quadrant 1)





Pin 2 is in electrical contact with the mounting base.

### absolute maximum ratings over operating case temperature (unless otherwise noted)

RATING			VALUE	UNIT
	TIC201D		400	
Repetitive peak off-state voltage (see Note 1)	TIC201M	V <sub>DRM</sub>	600	V
	TIC201S		700	
Full-cycle RMS on-state current at (or below) 85°C case temperature (see Note 2)			2.5	А
Peak on-state surge current full-sine-wave at (or below) 25°C case temperature (see Note 3)		I <sub>TSM</sub>	12	А
Peak gate current			±0.2	А
Peak gate power dissipation at (or below) 85°C case temperature (pulse width $\leq$ 200 $\mu$ s)			1.3	W
Average gate power dissipation at (or below) 85°C case temperature (see Note 4)			0.3	W
Operating case temperature range			-40 to +110	°C
Storage temperature range			-40 to +125	°C
Lead temperature 1.6 mm from case for 10 seconds	TL	230	°C	

NOTES: 1. These values apply bidirectionally for any value of resistance between the gate and Main Terminal 1.

- 2. This value applies for 50-Hz full-sine-wave operation with resistive load. Above 85°C derate linearly to 110°C case temperature at the rate of 100 mA/°C.
- 3. This value applies for one 50-Hz full-sine-wave when the device is operating at (or below) the rated value of on-state current. Surge may be repeated after the device has returned to original thermal equilibrium. During the surge, gate control may be lost.
- 4. This value applies for a maximum averaging time of 20 ms.

#### electrical characteristics at 25°C case temperature (unless otherwise noted )

	PARAMETER	TEST CONDITIONS			MIN	ТҮР	MAX	UNIT
I <sub>DRM</sub>	Repetitive peak off-state current	$V_D$ = rated $V_{DRM}$	I <sub>G</sub> = 0	T <sub>C</sub> = 110°C			±1	mA
I <sub>GT</sub>	Gate trigger current	$V_{supply} = +12 V \dagger$ $V_{supply} = +12 V \dagger$ $V_{supply} = -12 V \dagger$ $V_{supply} = -12 V \dagger$	R <sub>L</sub> = 10 Ω R <sub>L</sub> = 10 Ω R <sub>L</sub> = 10 Ω R <sub>L</sub> = 10 Ω	t <sub>p(g)</sub> > 20 μs t <sub>p(g)</sub> > 20 μs t <sub>p(g)</sub> > 20 μs t <sub>p(g)</sub> > 20 μs			5 -8 -10 25	mA

† All voltages are with respect to Main Terminal 1.

## PRODUCT INFORMATION



### electrical characteristics at 25°C case temperature (unless otherwise noted) (continued)

PARAMETER		TEST CONDITIONS			MIN	ТҮР	MAX	UNIT
		V <sub>supply</sub> = +12 V†	$R_L = 10 \Omega$	t <sub>p(g)</sub> > 20 μs		0.7	2.5	
V	Gate trigger	$V_{supply} = +12 V^{\dagger}$	$R_L = 10 \Omega$	t <sub>p(g)</sub> > 20 μs		-0.7	-2.5	v
V <sub>GT</sub>	voltage	$V_{supply} = -12 V^{\dagger}$	$R_L = 10 \Omega$	t <sub>p(g)</sub> > 20 μs		-0.7	-2.5	v
		$V_{supply} = -12 V^{\dagger}$	$R_L = 10 \Omega$	t <sub>p(g)</sub> > 20 μs		0.7		
V <sub>T</sub>	On-state voltage	I <sub>T</sub> = ±3.5 A	l <sub>G</sub> = 50 mA	(see Note 5)			±1.9	V
I <sub>Н</sub>	Holding current	V <sub>supply</sub> = +12 V†	I <sub>G</sub> = 0	Init' I <sub>TM</sub> = 100 mA			30	mA
		$V_{supply} = -12 V^{\dagger}$	$I_{G} = 0$	Init' I <sub>TM</sub> = - 100 mA			-30	IIIA
١ <sub>L</sub>	Latching current	V <sub>supply</sub> = +12 V†	(see Note 6)				40	mA
		$V_{supply} = -12 V^{\dagger}$	(See Note 0)				-40	IIIA
dv/dt	Critical rate of rise of	V <sub>DBM</sub> = Rated V <sub>DBM</sub>	l <sub>G</sub> = 0	T <sub>C</sub> = 110°C		±20		V/µs
	off-state voltage	VDRM - Mated VDRM		1 <sub>C</sub> = 110 0		120		•/µ3
dv/dt <sub>(c)</sub>	Critical rise of	V — Botod V	I <sub>TRM</sub> = ±3.5 A	T <sub>C</sub> = 85°C	±1	±4		V/µs
	commutation voltage	VDRM - Maled VDRM			- <u>-</u> 1	<u>-</u> 24		v/µs

† All voltages are with respect to Main Terminal 1.

NOTES: 5. This parameter must be measured using pulse techniques,  $t_p = \le 1$  ms, duty cycle  $\le 2$  %. Voltage-sensing contacts separate from the current carrying contacts are located within 3.2 mm from the device body.

6. The triacs are triggered by a 15-V (open circuit amplitude) pulse supplied by a generator with the following characteristics:  $R_G = 100 \Omega$ ,  $t_{p(g)} = 20 \mu s$ ,  $t_r = \le 15 ns$ , f = 1 kHz.

### thermal characteristics

PARAMETER			TYP	MAX	UNIT
$R_{\theta JC}$ Junction to case thermal resistance				10	°C/W
$R_{\theta JA}$ Junction to free air thermal resistance				62.5	°C/W

### PRODUCT INFORMATION